

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7920476

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	SECURITY INTEREST
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
COMPOLOGY LLC	04/25/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	AVIDBANK
<b>Street Address:</b>	1732 N. 1ST STREET, 6TH FLOOR
<b>City:</b>	SAN JOSE
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95112
<b>PROPERTY NUMBERS Total: 10</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	11172325
Patent Number:	10943356
Patent Number:	11122388
Patent Number:	11610185
Patent Number:	10798522
Application Number:	14211709
Application Number:	16570936
Application Number:	17161437
Application Number:	14479136
Application Number:	17145021
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6506483802
<b>Email:</b>	PATTY@PATTYCHENG.COM
<b>Correspondent Name:</b>	PATTY CHENG
<b>Address Line 1:</b>	2625 MIDDLEFIELD RD., #215
<b>Address Line 4:</b>	PALO ALTO, CALIFORNIA 94306
<b>NAME OF SUBMITTER:</b>	PATTY CHENG

<b>SIGNATURE:</b>	/s/ Patty Cheng
<b>DATE SIGNED:</b>	04/25/2023
<b>Total Attachments: 5</b> source=Roadrunner - IPSA (Compology)#page1.tif source=Roadrunner - IPSA (Compology)#page2.tif source=Roadrunner - IPSA (Compology)#page3.tif source=Roadrunner - IPSA (Compology)#page4.tif source=Roadrunner - IPSA (Compology)#page5.tif	

## INTELLECTUAL PROPERTY SECURITY AGREEMENT

**THIS INTELLECTUAL PROPERTY SECURITY AGREEMENT** is entered into as of April 25, 2023 by and between COMPOLOGY, LLC, a Delaware limited liability company formerly known as RR Tactical Merger Sub II LLC and successor in interest to Compology Inc. ("**Grantor**") and AVIDBANK, a California corporation ("**Bank**").

### RECITALS

Bank has agreed to make certain advances of money and to extend certain financial accommodations to Grantor in the amounts and manner set forth in that certain Loan and Security Agreement by and between Bank, Grantor and the other parties named therein, dated as of July 19, 2017 and as amended from time to time (the "**Loan Agreement**"). Capitalized terms used herein have the meaning assigned in the Loan Agreement. Bank is willing to make the financial accommodations to Grantor, but only upon the condition, among others, that Grantor grants to Bank a security interest in all of Grantor's right title, and interest in, to and under all of the Collateral whether presently existing or hereafter acquired.

**NOW, THEREFORE**, Grantor agrees as follows:

### AGREEMENT

To secure performance of Grantor's obligations under the Loan Agreement, Grantor grants to Bank a security interest in all of Grantor's right, title and interest in Grantor's intellectual property (including without limitation those Copyrights, Patents and Trademarks listed on Exhibits A, B and C hereto), including without limitation all proceeds thereof (such as, by way of example but not by way of limitation, license royalties and proceeds of infringement suits). This security interest is granted in conjunction with the security interest granted to Bank under the Loan Agreement. Each right, power and remedy of Bank provided for herein or in the Loan Agreement shall not preclude the simultaneous or later exercise by Bank of any or all other rights, powers or remedies.

Grantor represents and warrants that Exhibits A, B, and C attached hereto set forth any and all intellectual property rights in connection to which Grantor, as of the date hereof, has registered or filed an application with either the United States Patent and Trademark Office or the United States Copyright Office, as applicable. Grantor hereby authorizes Bank to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new intellectual property.

This Agreement may be executed in two or more counterparts, each of which shall be deemed an original but all of which together shall constitute the same instrument. In the event that any signature is executed and delivered by e-mail delivery of a ".pdf" format data file or electronic signature complying with the U.S. federal ESIGN Act of 2000, such signature shall create a valid and binding obligation of the party executing (or on whose behalf such signature is executed) with the same force and effect as if such ".pdf" or electronic signature page were an original hereof, with full legal force and effect, and the parties waive any rights they may have to object to such treatment.

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IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed as of the first date written above.

Address of Grantor:

105 40th Street, Suite 100  
Pittsburgh, PA 15201  
Attn: Legal Department

COMPOLOGY LLC

By: 

Print Name: Graham Rihn

Title: Chief Executive Officer

Address of Bank:

1732 N. 1st Street, 6th Floor  
San Jose, CA 95112  
Attn: Stephen Chen

AVIDBANK

By: 

Print Name: STEPHEN CHEN

Title: SVP

PATENT

REEL: 063437 FRAME: 0367

**EXHIBIT A**

**Copyrights**

Please Check Box if No Copyrights Exist ☒

<b>Title</b>	<b>Registration Number</b>	<b>Registration Date</b>
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**EXHIBIT B****Patents**

<b>Title</b>	<b>Patent Number</b>	<b>Application Number / Publication Number</b>
System and method for waste material management		14/211709 US20140278630
Method and system for contamination assessment		16/570936 US20200013024
Method and system for location measurement analysis	11172325	16/863609
Method and system for fill level determination		17/161437 US20210158097
System and method for waste management		14/479136 US20140379588
Method and system for fill level determination	10943356	16/709127 US20200193620
Method and system for container location analysis	11122388	17/013478 US20200404449
System and method for waste management	11610185	16/288593 US20190197498
Method and system for container location analysis	10798522	16/845997
Method and system for contamination assessment		17/145021 US20210158308

**EXHIBIT C**

**Trademarks**

<u>Description</u>	<u>Serial Number</u>	<u>Registration Number</u>	<u>Application Date / Registration Date</u>
WASTE METERING	90107421		*

*\* — indicates dead, abandoned or cancelled trademark*